BUF22821EVM-USB Evaluation Board and Software Tutorial

This user's guide describes the characteristics, operation, and use of the BUF22821EVM-USB evaluation board. It discusses how to set up and configure the software and hardware and reviews various aspects of the program operation. Throughout this document, the terms *evaluation board*, *evaluation module*, and *EVM* are synonymous with the BUF22821EVM-USB. This user's guide also includes information regarding operating procedures and input/output connections, an electrical schematic, printed circuit board (PCB) layout drawings, and a parts list for the EVM.

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1 Overview

The BUF22821 is a programmable gamma-voltage generator and V_{COM} calibrator. This device offers 22 programmable gamma channels, two programmable V_{COM} channels, and two static gamma channels, making it ideal for 10-bit source TFT-LCD reference drivers.

The BUF22821EVM-USB is a platform for evaluating the performance of the BUF22821 under various signal, reference, and supply conditions. This document gives a general overview of the BUF22821EVM-USB, and provides a general description of the features and functions to be considered while using this evaluation module.

1.1 BUF22821EVM-USB Kit Contents

Table 1 lists the contents of the BUF22821EVM-USB kit. Figure 1 shows all of the included hardware. Contact the Texas Instruments Product Information Center nearest you if any component is missing. It is highly recommended that you also check the BUF22821 product folder on the TI web site at www.ti.com to verify that you have the latest versions of the related software.

Table 1. BUF22821EVM-USB Kit Contents

Item	Quantity
BUF22821EVM-USB PCB Test Board	1
USB_DIG_Platform PCB	1
USB Cable	1
+6-V Power Supply	1
User's Guide CD-ROM	1

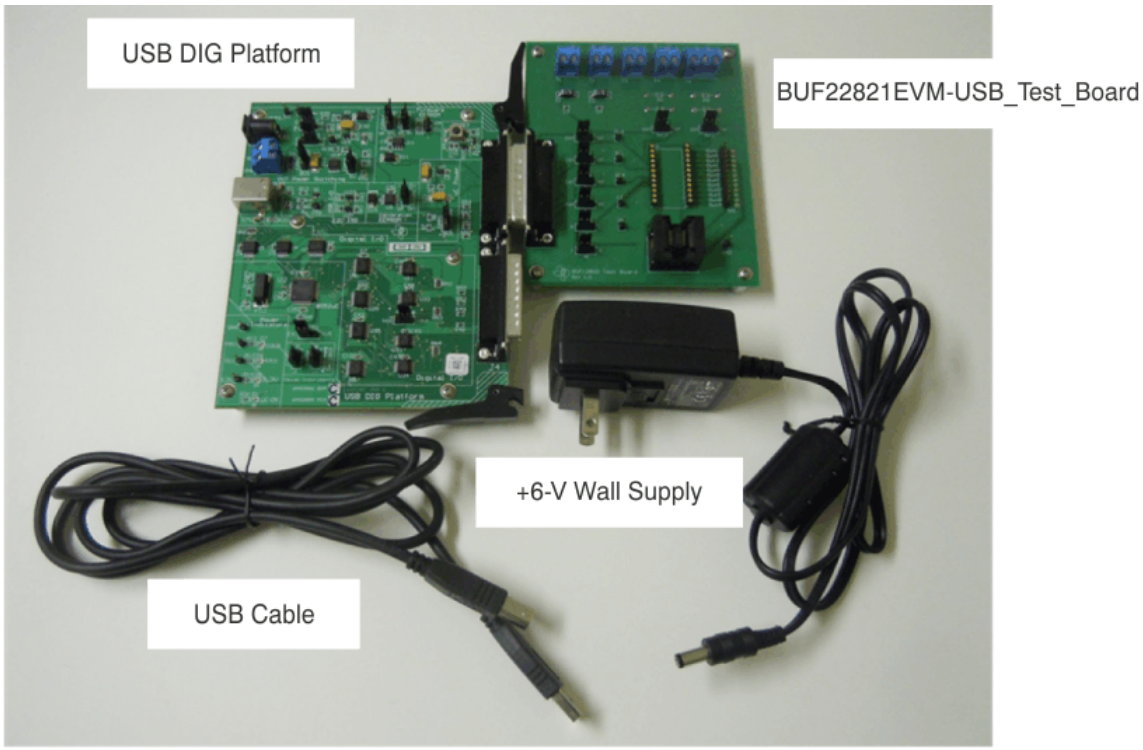

Figure 1. Hardware Included with BUF22821EVM-USB Kit

1.2 Related Documentation from Texas Instruments

The following documents provide information regarding Texas Instruments' integrated circuits used in the assembly of the BUF22821EVM-USB. This user's guide is available from the TI web site under literature number ***SBOU116***. Any letter appended to the literature number corresponds to the document revision that is current at the time of the writing of this document. Newer revisions may be available from the TI web site, or call the Texas Instruments' Literature Response Center at (800) 477-8924 or the Product Information Center at (972) 644-5580. When ordering, identify the document by both title and literature number.

Table 2. Related Documentation

Document	Literature Number
BUF22821 Product Data Sheet	SBOS399
USB_DIG_Platform User Guide	SBOU058

2 BUF22821EVM-USB Hardware Setup

This section discusses the overall system setup for the BUF22821EVM-USB. The PC runs software that communicates with the USB_DIG_Platform. The USB_DIG_Platform generates the analog and digital signals used to communicate with the BUF22821 test board. Connectors on the BUF22821 test board allow the user to connect to the system under various test conditions and monitor the power, current, and voltage. A block diagram of the overall hardware setup is shown in Figure 2.

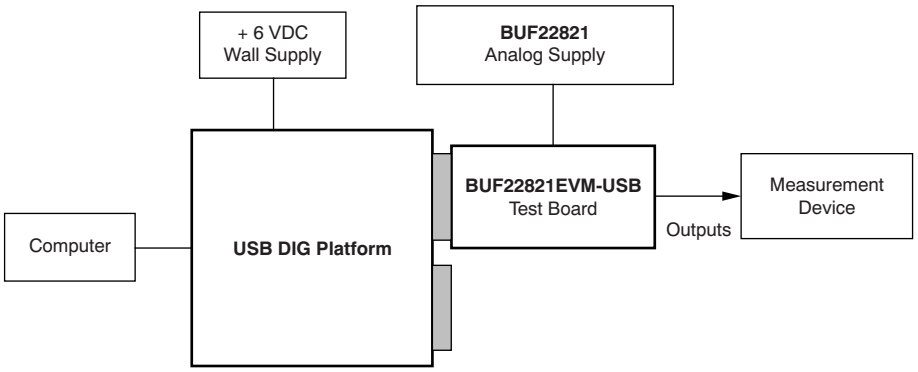

Figure 2. BUF22821EVM-USB Hardware Setup

2.1 Theory of Operation for BUF22821 Hardware

Figure 3 shows the BUF22821 test board hardware setup. The functionality of the PCB is such that it provides connections to the I²C™ and general-purpose inputs/outputs (GPIOs) on the USB_DIG_Platform board. It also provides connection points for external connections of the shunt voltage, bus voltage, and ground.

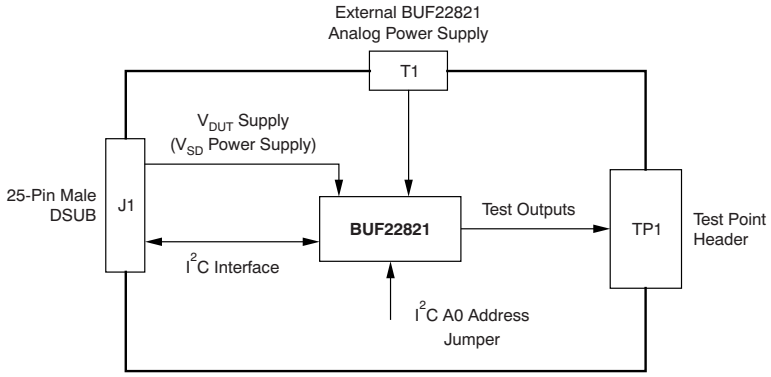

Figure 3. BUF22821EVM-USB Board Block Diagram

2.2 Signal Definitions of J1 (25-Pin Male DSUB)

Table 3 shows the various signals connected to J1 on the BUF22821 test board.

Table 3. J1 Signal Definition for BUF22821EVM-USB

Pin No on U1	Signal	BUF22821 Pin
1	N/C	No connection
2	N/C	No connection
3	N/C	No connection
4	N/C	No connection
5	N/C	No connection
6	N/C	No connection
7	N/C	No connection
8	N/C	No connection
9	I2C_SCK	No connection
10	I2C_SDA2	No connection
11	N/C	No connection
12	I2C_SCK_ISO	I²C clock signal (SCL) channel 1; can be disconnected using a switch
13	I2C_SDA_ISO	I²C data signal (SDA) channel 1; can be disconnected using a switch
14	N/C	No connection
15	N/C	No connection
16	N/C	No connection
17	V_{DUT}	Switched 3-V/5-V power(1)
18	V_{CC}	No connection
19	N/C	No connection
20	N/C	No connection
21	GND	Common ground connection
22	SPI_SCK	No connection
23	SPI_CS1	No connection
24	SPI_DOUT1	No connection
25	SPI_DIN1	No connection

(1) When power is switched off, digital I/O is also switched off.

2.2.1 Theory of Operation for USB_DIG_Platform

Figure 4 shows the block diagram for the USB_DIG_Platform. This platform is a general-purpose data acquisition system that is used on several different Texas Instruments evaluation modules. The details of its operation are included in a separate document, SBOU058 (available for download at www.ti.com). The block diagram shown in Figure 4 gives a brief overview of the platform. The primary control device on the USB_DIG_Platform is the TUSB3210.

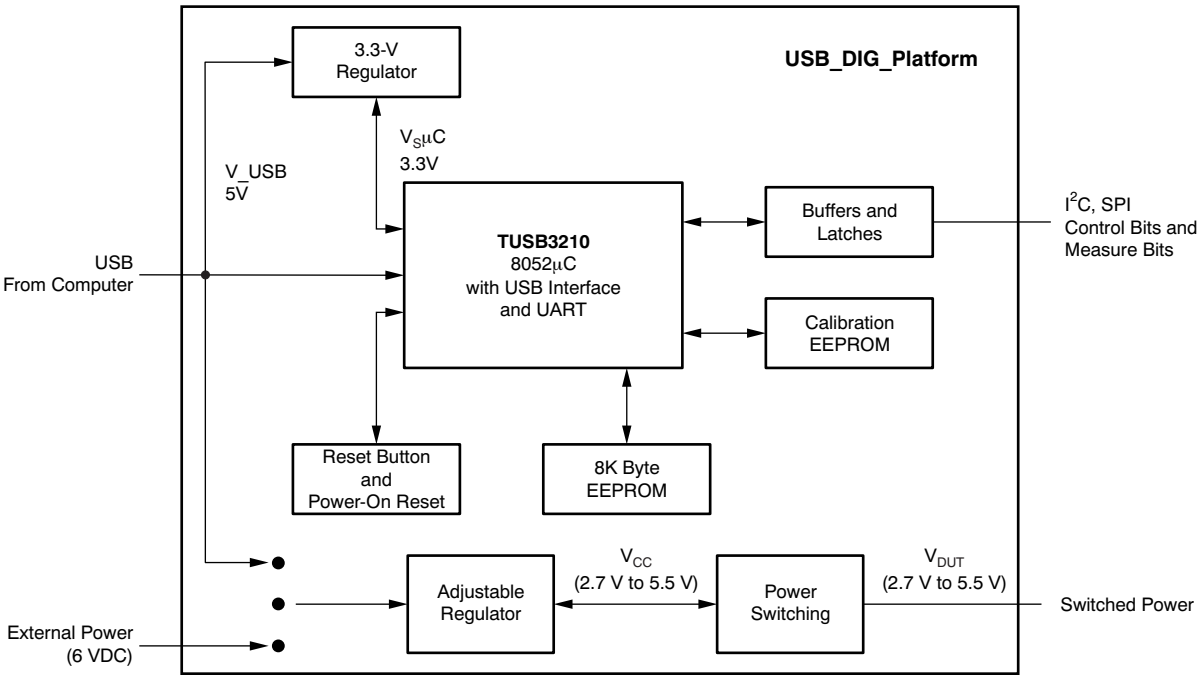

Figure 4. USB_DIG_Platform Block Diagram

3 BUF22821EVM-USB Hardware

This section provides details about connecting the two PCBs of the BUF22821EVM-USB together, applying power, connecting the USB cable, and setting the jumpers.

3.1 Electrostatic Discharge Warning

CAUTION

Many of the components on the BUF22821EVM-USB are susceptible to damage by electrostatic discharge (ESD). Customers are advised to observe proper ESD handling precautions when unpacking and handling the EVM, including the use of a grounded wrist strap at an approved ESD workstation.

3.2 Typical Hardware Connections

Setting up the BUF22821EVM-USB hardware involves connecting the BUF22821 test board and the USB_DIG_Platform together via a 25-pin DSUB connector and then applying power. The external connections may be connected to the real-world system that the BUF22821 is to be incorporated into. Figure 5 shows the typical hardware connections.

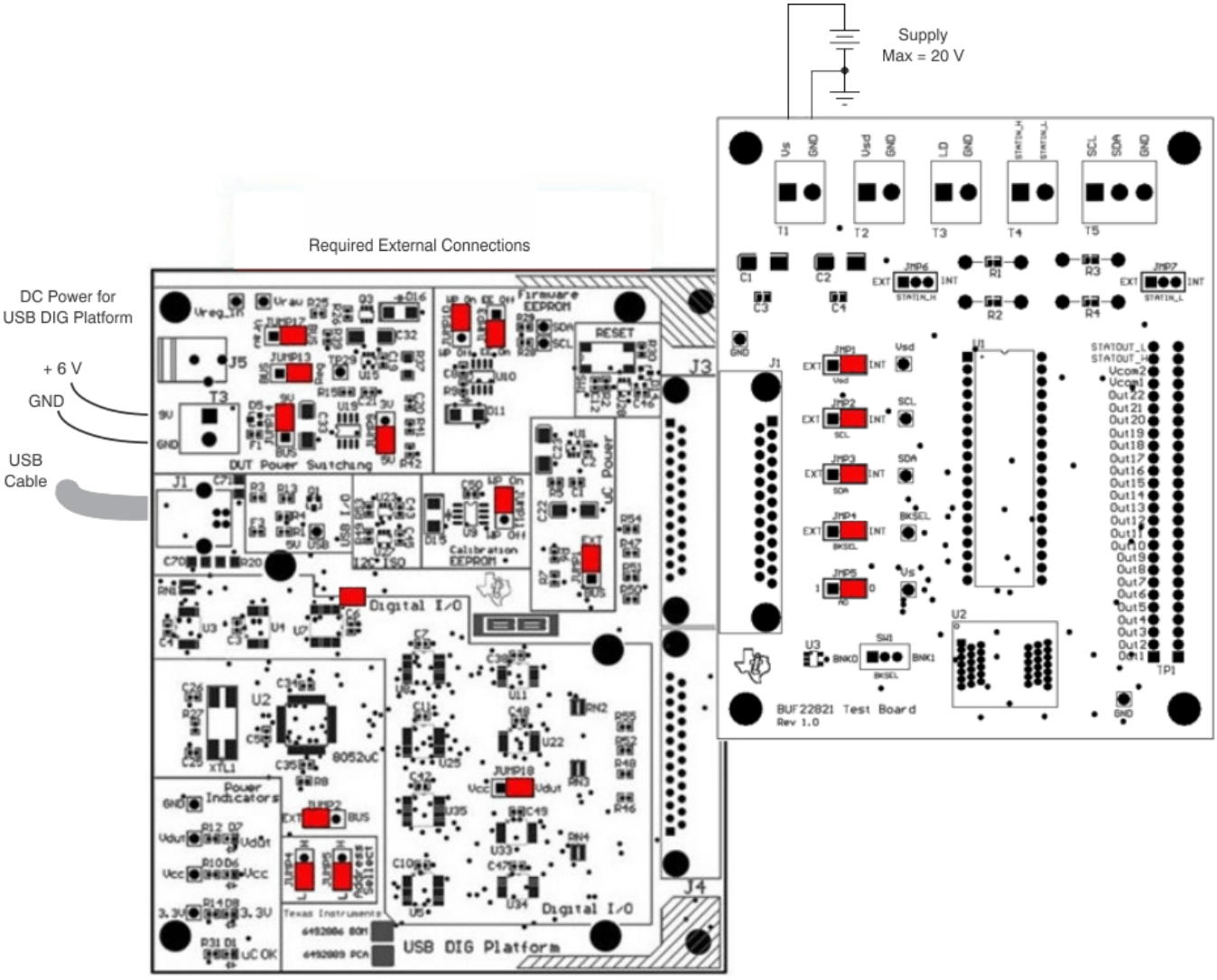

Figure 5. Typical Hardware Connections for the BUF22821EVM-USB

3.3 Connecting the Hardware

To connect the BUF22821 Test Board and the USB_DIG_Platform together, gently push on both sides of the DSUB connectors. Note that the USB_DIG_Platform board has two DSUB connectors; either DSUB connector may be used. Make sure that the two connectors are completely pushed together; loose connections may cause intermittent operation.

3.4 Connecting Power

After the boards are conjoined, connect the +6-V wall supply to the USB_DIG_Platform board as shown in Figure 6. Note that it is always necessary to connect the power to the DIG before connecting the USB cable. If the USB cable is connected before the power, the computer may attempt communication to an unpowered device that is unable to respond. In addition, the BUF22821 test board requires an external dc power source. This source is not included with the kit, and its voltage may differ depending on your testing needs. The source will be used to provide dc supply voltage to the BUF22821 test board.

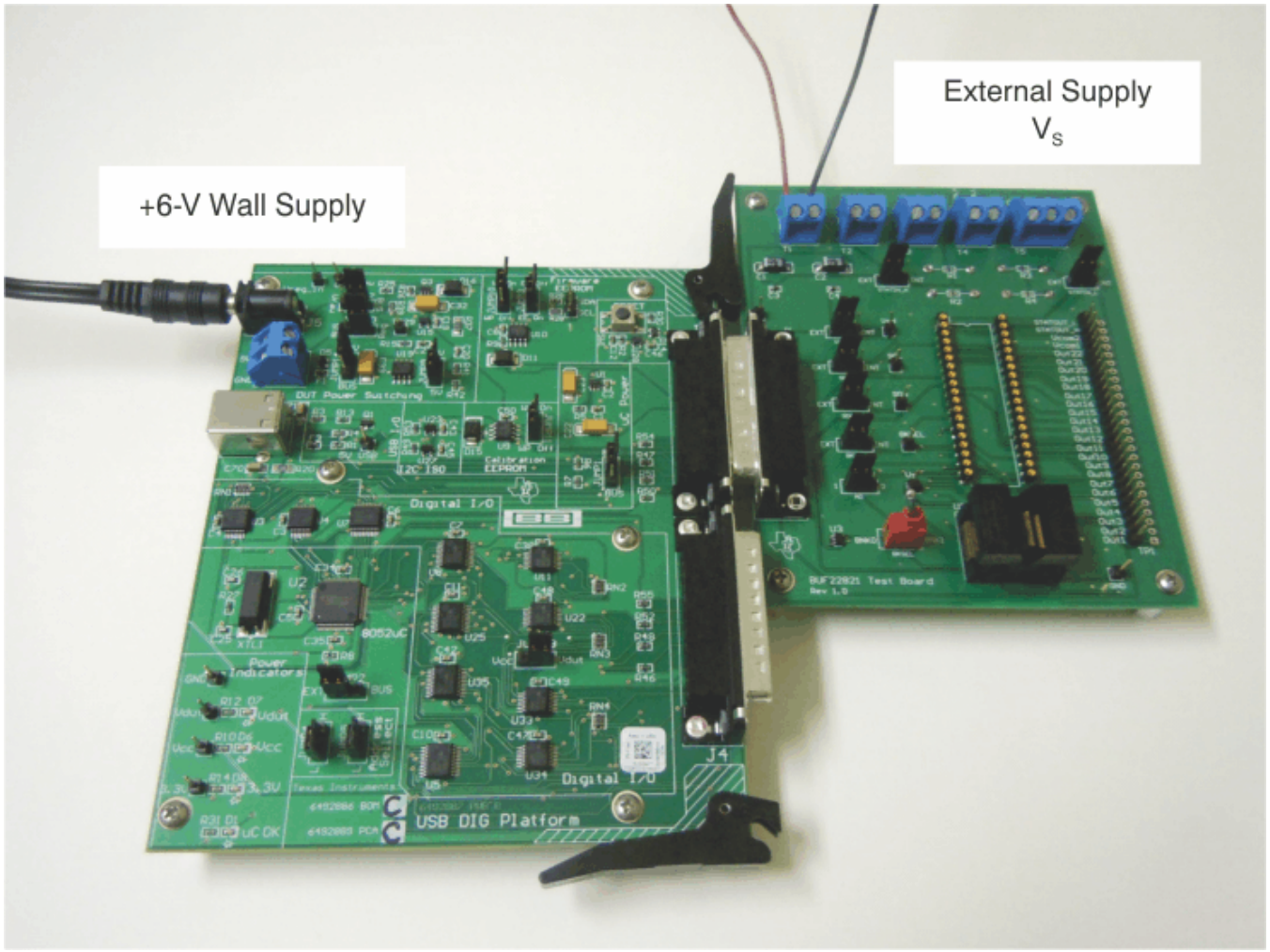

Figure 6. Connecting External Power to the BUF22821EVM-USB

3.5 Connecting the USB Cable to the USB_DIG_Platform

Once power is connected, the USB cable must be connected to the DIG, as shown in Figure 7.

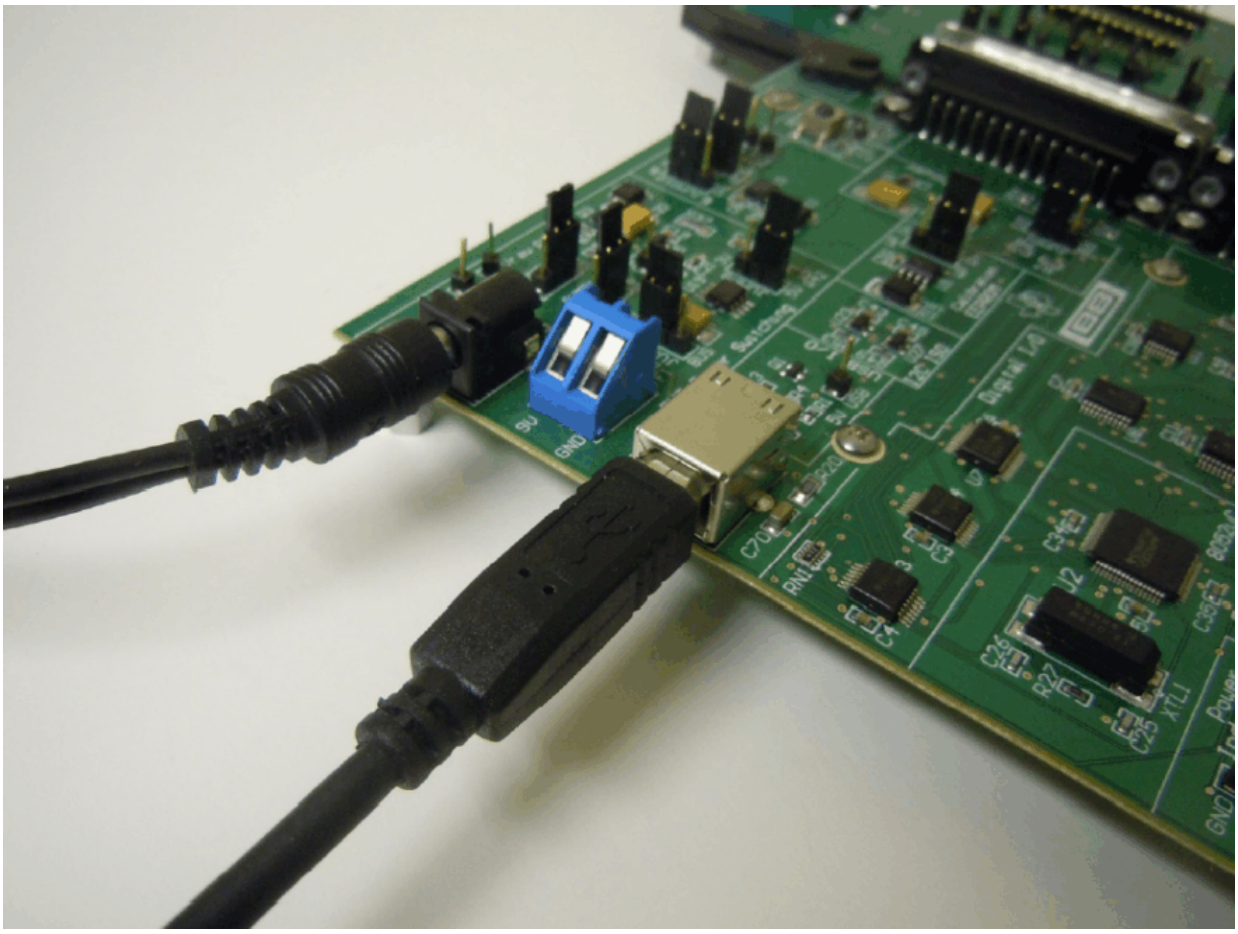

Figure 7. Connecting the USB Cable to the USB_DIG_Platform

Note that the Test Board and USB_DIG_Platform must be powered on before connecting the USB cable. Typically, the computer responds with a *Found New Hardware, USB Device* pop-up dialog. The popup window typically changes to *Found New Hardware, USB Human Interface Device*. This pop-up window indicates that the device is ready to be used. The USB_DIG_Platform uses the human interface device drivers that are part of the Microsoft® Windows® operating system.

In some cases, the Windows *Add Hardware* wizard is shown. If this prompt appears, allow the system device manager to install the human interface drivers by clicking ***Yes*** when requested to install drivers. Windows then confirms installation of the drivers with the message shown in Figure 8.

Figure 8. Confirmation of USB_DIG_Platform Driver Installation

3.6 BUF22821EVM-USB Default Jumper Settings

Figure 9 shows the default jumpers configuration for the BUF22821EVM-USB. In general, the jumper settings of the USB_DIG_Platform do not need to be changed. You may want to change some of the jumpers on the BUF22821 Test Board to match your specific configuration. For instance, you may wish to set a specific I^2C address.

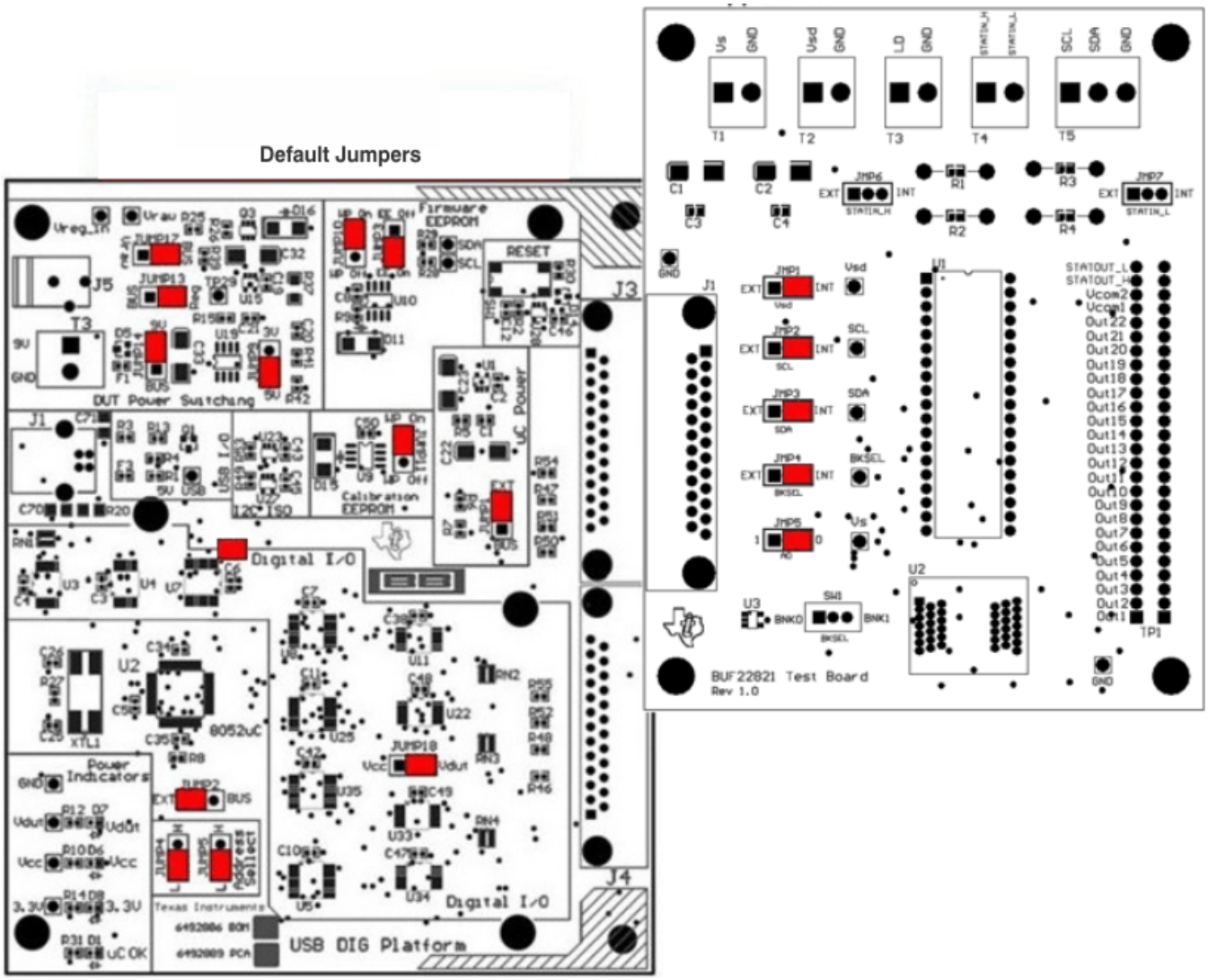

Figure 9. Default Jumper Locations for BUF22821EVM-USB

Table 4 summarizes the function of the BUF22821 Test Board jumpers. For most application, jumpers 2 through 5 are all set to the default positions.

Table 4. BUF22821 Test Board Jumper Functions

Jumper	Default	Purpose/Description
JMP1	INT	This jumper selects whether the V_{SD} pin on the BUF22821 is connected to the V_{DUT} signal generated from the USB_DIG_Platform or whether the digital supply pin is connected to terminal T2, allowing for an external supply to power the digital circuitry. The default INT position connects the V_{SD} pin to the V_{DUT} control signal.
JMP2	INT	This jumper selects whether the SCL pin on the BUF22821 is connected to the I2C_SCK_ISO signal generated from the USB_DIG_Platform or whether the SCL pin is connected to terminal T5, allowing for an external source to control the I^2C clock line. The default INT position connects the SCL pin to the I2C_SCK_ISO control signal.
JMP3	INT	This jumper selects whether the SDA pin on the BUF22821 is connected to the I2C_SDA_ISO signal generated from the USB_DIG_Platform or whether the SDA pin is connected to terminal T5, allowing for an external source to control the I^2C data line. The default INT position connects the SDA pin to the I2C_SDA_ISO control signal.
JMP4	INT	This jumper selects whether the BKSEL pin on the BUF22821 is controlled by the manual switch located on the BUF22821 EVM or whether the BKSEL can be controlled by an external source connected to terminal T3. The default INT position allows the BKSEL pin to be controlled by the manual switch.
JMP5	0	This jumper selects I^2C A0 address selection. Two separate I^2C addresses can be selected, depending on whether JMP6 is set to high or low.
JMP6	No Connection	This jumper selects whether or not the STATIN_H pin on the BUF22821 is connected to the V_S signal generated by the external analog power supply input at terminal T1, or whether the STATIN_H pin is connected to a user-designated reference, which is set using an external input at terminal T4 as well as resistors R1 and R2. The default position leaves the STATIN_H connection open.
JMP7	No Connection	This jumper selects whether or not the STATIN_L pin on the BUF22821 is connected to ground or whether the STATIN_L pin is connected to a user-designated reference, which is set using an external input at terminal T4 as well as resistors R3 and R4. The default position leaves the STATIN_L connection open.

Table 5 summarizes the function of the USB_DIG_Platform jumpers. For most applications, the default positions should be used. A separate document (SBOU058) provides details regarding the operation and design of the USB_DIG_Platform.

Table 5. USB_DIG_Platform Jumper Functions

Jumper	Default	Purpose/Description
JUMP1	EXT	This jumper selects external power or bus power. External power is applied on J5 or T3 (up to +9 V DC). Bus power is +5 V from the USB. External power is typically used because the USB bus power introduces additional noise.
JUMP2	EXT	Same as JUMP1.
JUMP3	EE ON	This jumper determines where the TUSB3210 loads the USB_DIG_Platform firmware upon power-up or reset. The *EE Off* position is used for development or firmware update.
JUMP4, JUMP5	L, L	This jumper sets the address for the USB_DIG_Platform board. The only reason to change from the default is if multiple boards are being used.
JUMP9	5V	This jumper selects the voltage of the device under test supply (V_{DUT} = 5 V or 3 V). This jumper is typically the only jumper that changes for most applications.
JUMP10	WP ON	This write protects the firmware EEPROM.
JUMP11	WP ON	This write protects the calibration EEPROM.
JUMP13	REG	Uses the regulator output to generate the V_{DUT} supply. The USB bus can be used as the V_{DUT} supply.
JUMP14	9V	Uses the external power (9 V as opposed to the bus)
JUMP17	BUS	While in the BUS position, V_{DUT} operation is normal. While in the V_{RAW} position, the V_{DUT} supply is connected to an external source. This configuration allows for any value of V_{DUT} between 3 V and 5 V.(1)
JUMP18	V_{DUT}	Connects the pull-up on GPIO to the V_{DUT} supply or the V_{CC} supply.

(1) Adjusting beyond this range damages the EVM.

4 BUF22821EVM-USB Features

This section describes some of the hardware features present on the BUF22821 Test Board.

4.1 JMP1: V_{SD} Control Setting

Jumper JMP1 selects where the BUF22821 digital supply pin is connected. If JMP1 is set to the INT position, the DV_{DD} pin is connected to the switchable V_{DUT} signal generated from the USB_DIG_Platform. This voltage can be set to either +3.3 V or +5 V, depending on how JUMP9 on the USB_DIG_Platform is set. While JMP1 is set to the INT position, the V_{SD} Power button on the BUF22821 software is able to control whether the V_{DUT} supply voltage is turned on or off.

When JMP1 is set in the EXT position, an external supply connected to terminal T2 can be used to provide the digital supply voltage for the BUF22821.

4.2 JMP2: I²C SCL Control Setting

Jumper JMP2 selects where the BUF22821 I²C SCL pin is connected. If JMP2 is set to the INT position, the I²C clock signal is generated from the I2C_SCK_ISO signal from the USB_DIG_Platform.

When JMP2 is set in the EXT position, an external source connected to SCL pin of terminal T5 can be used to provide the I²C SCK signal to the BUF22821.

4.3 JMP3: I²C SDA Control Setting

Jumper JMP3 selects where the BUF22821 I2C SDA pin is connected. If JMP3 is set to the INT position, the I²C data signal is generated from the I2C_SDA_ISO signal from the USB_DIG_Platform.

When JMP3 is set in the EXT position, an external source connected to SDA pin of terminal T5 can be used to provide the I²C SDA signal for the BUF22821.

4.4 JMP4: BKSEL Control Setting

Jumper JMP4 determines how the OTP memory bank selection is controlled. There are two settings for JMP4: position INT and position EXT. Position INT specifies that control of the BKSEL pin is handled on the BUF22821 Test Board. For this jumper setting, the BKSEL switch controls whether the Bank0 or Bank1 OTP is selected (as shown in Figure 10).

When JMP4 is set to the EXT position, an external control signal connected to terminal T3 determines the selection of which OTP bank to be used.

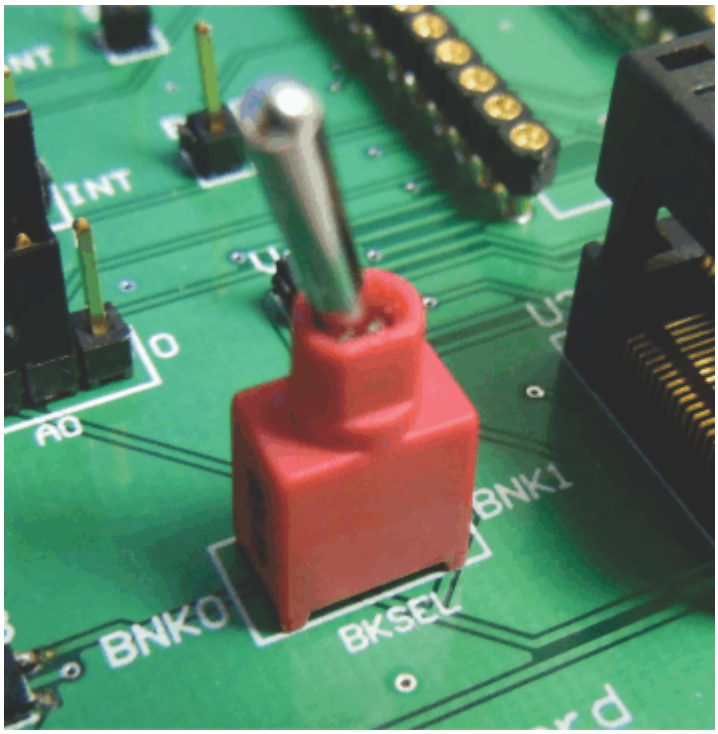

Figure 10. BKSEL Switch

4.5 JMP5: I²C Address Hardware Setting

Jumper JMP5 sets the hardware configuration for the A0 I²C address pin on the BUF22821. Using JMP5, the A0 address can be set to either a logic '1' or a logic '0' to allow for two unique I²C addresses. See Section 6.2.1 on how to configure the BUF22821EVM-USB software to match the JMP5 hardware setting.

4.6 JMP6: STATIN_H Control Setting

Jumper JMP6 is selects where the BUF22821 high reference supply pin STATIN_H is connected. If JMP6 is set to the INT position, STATIN_H is connected to V_S, the external analog supply input at terminal T1.

When JMP6 is set to the EXT position, the reference voltage is then designated by the user with the STATIN_H pin of terminal T4, along with resistors R1 and R2. An external power supply is connected to the STATIN_H pin of terminal T4, and R1 and R2 act as a voltage-divider circuit; the user sets the values of R1 and R2 to achieve the desired reference voltage using Equation 1:

$$STATIN\_L = V_{SUP\_H}\left(\frac{R2}{R1 + R2}\right) \quad (1)$$

Where V_{SUP_H} is the input supply voltage seen at the STATIN_H pin of terminal T4.

4.7 JMP7: STATIN_L Control Setting

Jumper JMP7 is selects where the BUF22821 high reference supply pin STATIN_L is connected. If JMP8 is set to the INT position, STATIN_L is connected to ground.

When JMP7 is set to the EXT position, the reference voltage is then designated by the user with the STATIN_L pin of terminal T4, along with resistors R3 and R4. An external power supply is connected to the STATIN_L pin of terminal T4, and R3 and R4 act as a voltage-divider circuit; the user sets the values of R3 and R4 to achieve the desired reference voltage using Equation 2:

$$STATIN\_L = V_{SUP\_L}\left(\frac{R4}{R3 + R4}\right) \quad (2)$$

Where V_{SUP_L} is the input supply voltage seen at the STATIN_L pin of terminal T4.

4.8 BUF22821 Device Placement

The BUF22821EVM-USB provides two separate locations on the board where the BUF22821 test device can be installed.

Location U1 allows for a BUF22821 device that is soldered down on a DIP adaptor board to be installed on the BUF22821 Test Board. The output capability of the BUF22821 that is soldered on this adaptor board can be fully evaluated. The PowerPAD™ of this soldered BUF22821 is connected correctly and allows the device to dissipate the necessary power while being evaluated.

Location U2 on the BUF22821 Test Board is a 24-pin, QFN-package test socket that allows the user to evaluate and program many devices very quickly. One drawback to this socket is that there is no connection to the PowerPAD of the BUF22821. Because of this limitation, while the device is placed in this socket, it cannot be operated to its full output capability as a result of thermal dissipation limitations.

CAUTION

Only one location should be populated at a time. The use of both locations simultaneously will likely damage one or both of the devices under test.

4.9 Terminal Strip TP1

Terminal strip TP1 provides the individual output signals on a single row of headers as well as a row of vias. This footprint offers the user multiple options to interface the output signals of the BUF22821 with an available display panel (provided by the user). The user can also develop a custom cable to connect the headers to this panel directly, or to solder the headers directly to the individual vias.

5 BUF22821EVM-USB Software Setup

This section discusses how to install the BUF22821EVM-USB software.

5.1 BUF22821EVM-USB Software Operating Systems

The BUF22821EVM-USB software has been tested on Microsoft Windows XP, Vista, and Windows7 operating systems (OS) with United States and European regional settings. The software should also function on other Windows OS platforms.

5.2 BUF22821 Software Installation

The BUF22821EVM-USB software is included on the CD that is shipped with the EVM kit. It is also available through the BUF22821EVM-USB product folder on the TI web site. To download the software to your system, insert the disc into an available CD-ROM drive. Navigate to the drive contents and open the BUF22821EVM-USB software folder. Locate the compressed file (*BUF22821EVM-USB.zip*) and open it. Using WinZIP®® or a similar file compression program; extract the BUF22821EVM-USB files into a specific BUF22821EVM-USB folder (for example, *C:\BUF22821EVM-USB*) on your hard drive.

Once the files are extracted, navigate to the BUF22821EVM-USB folder you created on your hard drive. Locate the *setup.exe* file and execute it to start the installation. The BUF22821 software installer file then opens to begin the installation process, as shown in Figure 11.

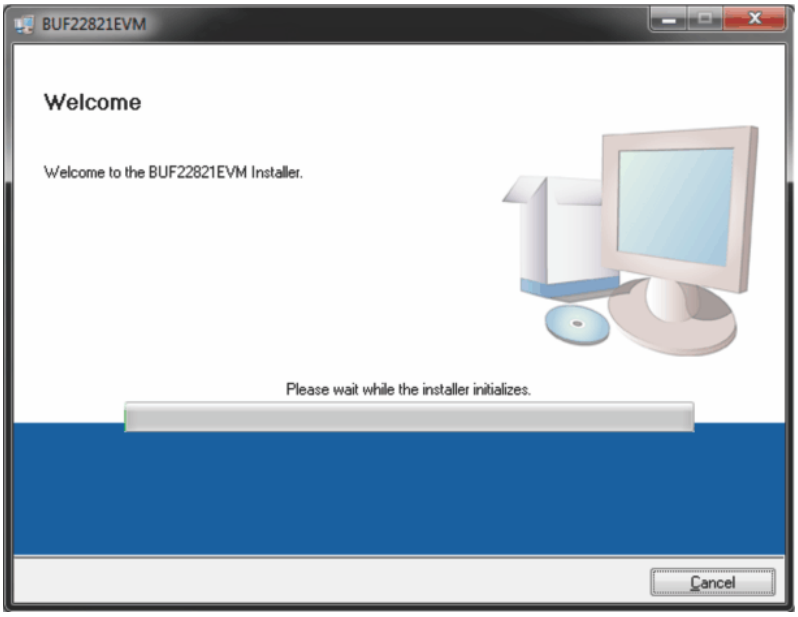

Figure 11. BUF22821EVM-USB Software Install Window

After the installation process initializes, the user is given the choice of selecting the directory to install the program. Generally, defaulting to *C:\Program Files\BUF22821* and *C:\Program Files\National Instruments* is an acceptable choice. Following this option, two license agreements are presented that must be accepted as shown in Figure 12.

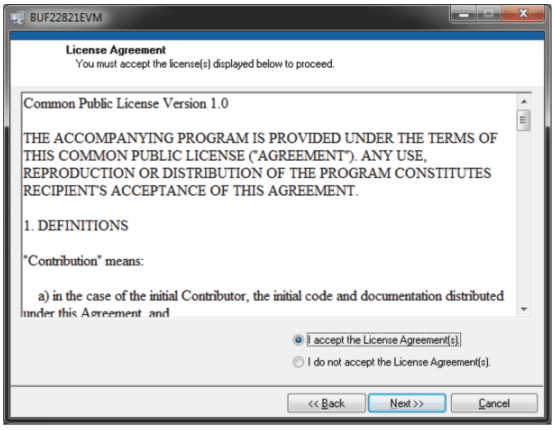

Figure 12. BUF22821EVM-USB Software License Agreements

After accepting the Texas Instruments and National Instruments license agreements, the progress bar opens and shows the installation of the software, as Figure 13 illustrates. Once the installation process is completed, click **Finish**.

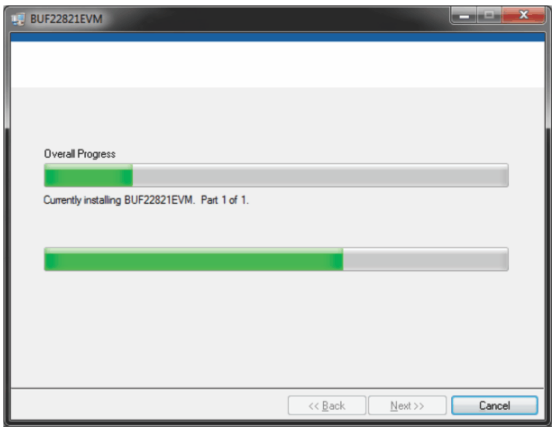

Figure 13. BUF22821EVM-USB Software Installation Progress

5.3 Software Description and Set-Up

The BUF22821EVM-USB software allows the user to read and write to all registers in the BUF22821 gamma correction buffer. Furthermore, it allows programming of the OTP register on the BUF22821. The software also permits the user to select either I^2C address. Press the **About** button to verify that you have the latest version of the software; the contents of this window are shown in Figure 14 .

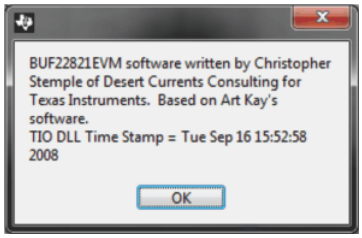

Figure 14. BUF22821EVM-USB Software About Button

6 BUF22821EVM-USB Software Overview

This section discusses how to use the BUF22821EVM-USB software.

6.1 Starting the BUF22821EVM-USB Software

The BUF22821EVM-USB software can be operated through the *Start* menu in Windows. From the Start menu, select *All Programs*, and then select the *BUF22821EVM-USB* program to start the software. Figure 15 shows how the software should appear if the BUF22821EVM-USB is functioning properly.

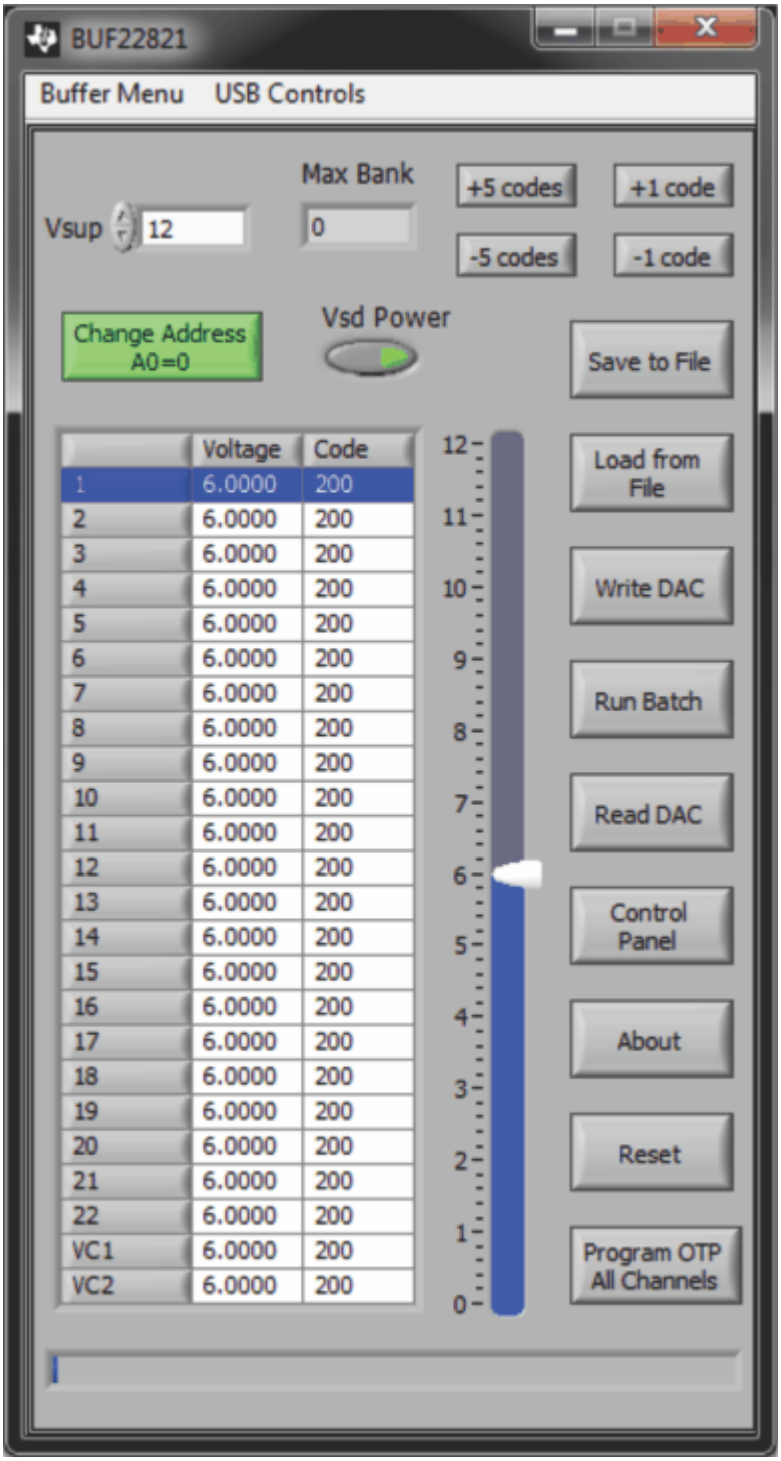

Figure 15. BUF22821EVM-USB Software Interface

Figure 16 shows an error that pops up if the computer cannot communicate with the EVM. If you receive this error, first ensure that the USB cable is properly connected on both ends. This error can also occur if you connect the USB cable before the USB_DIG_Platform power source. Another possible cause for this error is a problem with the USB Human Interface Device Driver on the computer you are using. Make sure that the device is recognized when the USB cable is plugged in; this action is indicated by a Windows-generated confirmation sound.

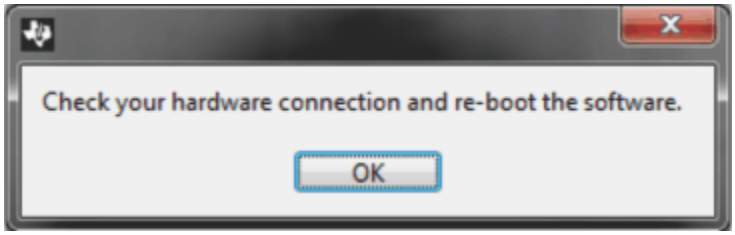

Figure 16. Communication Error with USB_DIG_Platform

6.2 Using the BUF22821 Software

6.2.1 I²C Address Selection

As mentioned previously (refer to Section 4.5), jumper JMP5 is used to set the I²C address pin of the BUF22821. Figure 17 shows how the hardware and software must both be set to enable communication between the BUF22821EVM-USB and the software. Without jumper JMP5 and the software address button configured correctly, the software cannot communicate with the BUF22821 device.

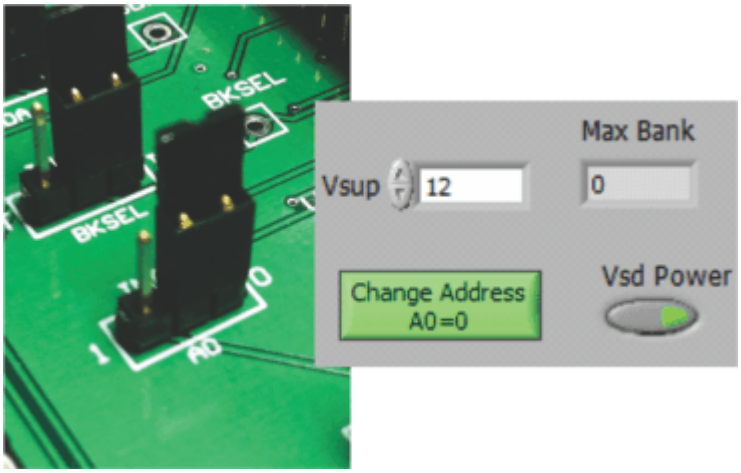

Figure 17. JMP5 Setting for Logic '0'

When JMP5 and the software are set as shown in Figure 18, the second I^2C address can be configured.

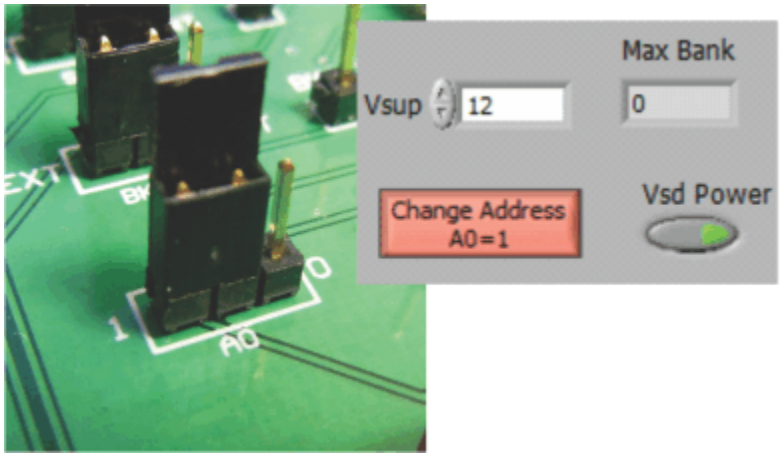

Figure 18. JMP5 Setting for Logic '1'

6.2.2 Measuring the Power Supply

You must measure the power supply (V_S) with respect to the GND on the BUF22821 Test Board and enter it in the *Vsup* field located in the top section of the software interface as shown in Figure 19.

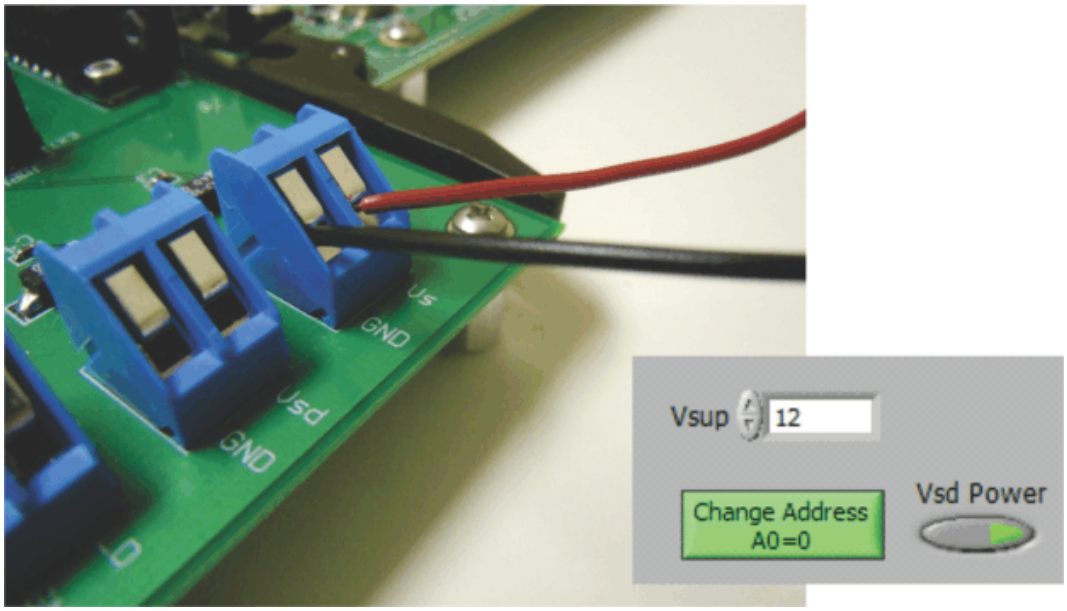

Figure 19. Measuring and Entering Power-Supply Voltage

The voltage out of each digital-to-analog converter (DAC) is calculated according to the V_S value entered.

Changing the value in the channel 6 cell as shown below, for instance, immediately changes the output of channel 6 to 0.996 V. The calculation is performed according to Equation 3.

$$V_{DAC\_CHANNEL} = \frac{V_S \times Code\_in\_decimal}{1024} \quad (3)$$

For example:

Channel 6: Code 44 (hexadecimal) = 68 (decimal)

$$V_{DAC\_CHANNEL} = \frac{15\ V \times 68}{1024} = 0.996\ V \quad (4)$$

6.2.3 Read DAC Button

By pressing the **Read DAC** button in the BUF22821EVM-USB software, all of the BUF22821 DAC registers are read to obtain the respective current register contents. Once the read procedure is complete, all of the corresponding text boxes are updated to show the current values present in the DAC registers.

6.2.4 Write DAC Button

The method used to write the values in the DAC registers is based on whether or not the Auto Write feature is enabled. The BUF22821 has two methods of writing information into the DAC registers. The first method allows for the output voltage to change immediately after the writing to the DAC register. In the BUF22821EVM-USB software, this mode is configured by enabling the Auto Write feature found in the *Buffer Menu* drop-down menu. In this mode, as an individual channel is written to, the output voltage changes as soon as the user moves to a different text box in the software.

The second method of writing to the DAC registers allows for the user to write multiple channels and then have all of the output voltages change at the same time, rather than each channel voltage changing as soon as it is written to. Disabling the Auto Write feature in the software allows the user to enter all of the desired values for all of the channels, and then press the **Write DAC** button to change all of the output voltage of all of the channels at one time. When the Auto Write feature is enabled, no change occurs to the output voltages when the **Write DAC** button is pressed. This action occurs because after the text box for a given channel has been updated, as soon as another item in the software is clicked, the Auto Write feature automatically performs a write command to the updated channel that then updates the output voltage. When in the Auto Write enabled mode, the Write DAC button cannot be pressed with data in the corresponding channel text boxes that are different than the values already stored in the DAC register; no change to the DAC registers will occur. Figure 20 shows the location in the Buffer Menu with the Auto Write feature enabled. Click the Auto Write feature again to enable/disable the feature, depending upon its current state.

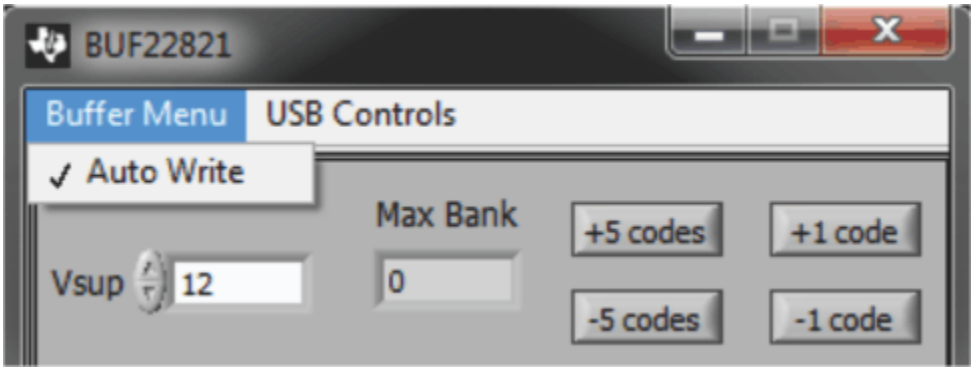

Figure 20. Auto Write Feature Enabled

6.2.5 Reset Button

Pressing the **Reset** button in the BUF22821EVM-USB software performs two functions. First, a General-Call Reset for the BUF22821 is performed. The status of the DAC registers after this General-Call Reset default to *1000000000*, or mid-supply. The second function performed after the **Reset** button is pressed is that a Read DAC call is made to update the corresponding channel text boxes to the current value for each channel.

6.2.6 Save to File Button

The register configurations of the BUF22821 DACs are displayed in both analog voltage and in hexadecimal (refer to Figure 15). The DAC codes (that is, gamma voltages) can also be saved to a text file (.txt) using the **Save to File** button.

Pressing the **Save to File** button opens a file-save dialog box similar to that shown in Figure 21. Pressing the folder icon creates a new folder on your PC. It is a good idea to create a directory exclusively for BUF22821 DAC code (gamma voltage) files. Enter a unique file name in the *File name* field to store your BUF22821 register information. Press the **OK** button to save the file.

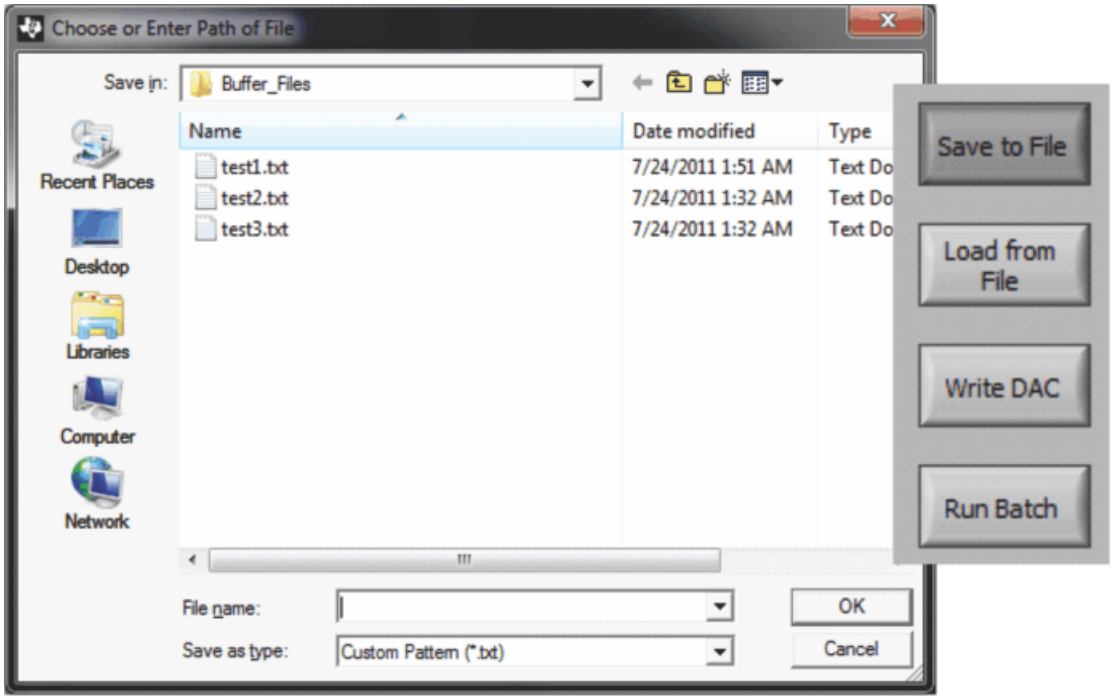

Figure 21. Save File Prompt

Saving the BUF22821 DAC codes (gamma voltages) creates a text file that can be opened in a text editor, as illustrated in Figure 22.

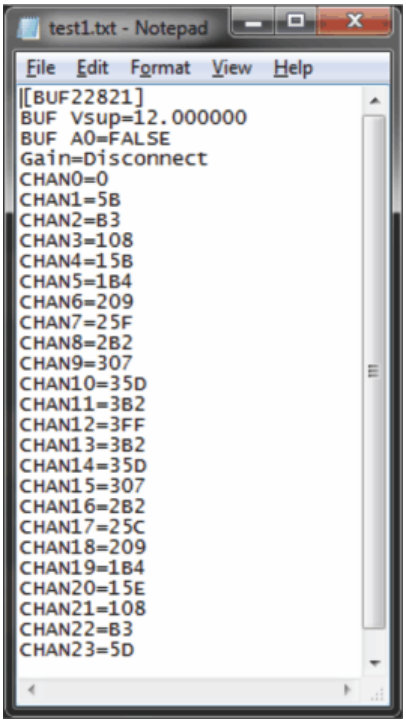

Figure 22. Saved Data Format

6.2.7 Load From File Button

The BUF22821EVM-USB software is also able to load data saved from previous evaluations. A saved register configuration can be loaded into the BUF22821 using the **Load From File** button, shown in Figure 23. The program recalls where you saved the last register configuration. Simply select the desired configuration and press **Open**.

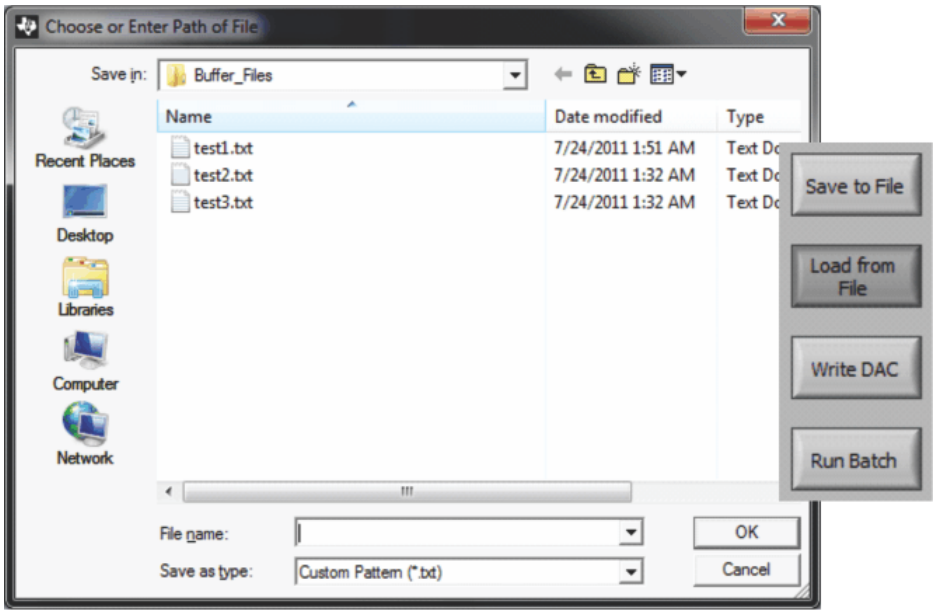

Figure 23. Load File Prompt

6.2.8 Changing DAC Analog Voltage

The voltage of any of the DAC channels can be adjusted in several ways. One way is to change the voltage by entering the desired voltage directly in the voltage text box. In order to be able to manually type the voltage into the text box, first click on the cell to be edited. Click a second time and the cell turns from blue to black and allows the updated voltage to be typed in the cell. The hexadecimal DAC codes can be entered in the *Code* column in the same manner.

Another method of changing the voltage of a DAC channel is through the use of the slider on the main software window (refer to Figure 15). There is only a single slider that is used for all channels. In order to use the slider to adjust the voltage of a particular channel, the channel must first be selected. Clicking on either the channel number, voltage, or code of a particular channel highlights the entire channel row and makes it blue to indicate which channel is selected. Adjusting the slider bar then only updates the highlighted channel.

The final method to change the DAC voltages is through the **±1 Code** and **±5 Code** buttons on the main software window. These buttons allow for fine and coarse adjustments to the highlighted channel to allow the user to quickly step the channel output up or down as needed, without having to manually enter the changes in the Code column.

6.2.9 Run Batch Button

The **Run Batch** button (as indicated in Figure 24) enables the user to configure the BUF22821 to cycle through different register configurations in a continuous loop. When connected to the end application, this feature can be used to cycle through different gamma settings to determine what the optimal settings must be for a given application.

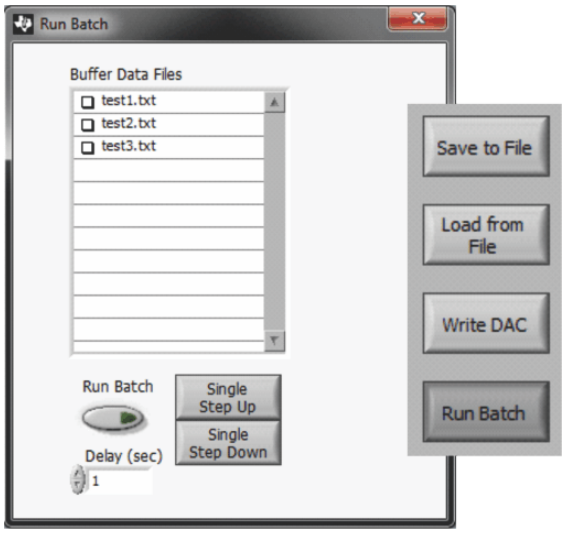

Figure 24. Run Batch Dialog

When the **Run Batch** button is pressed, a new dialog box displays as Figure 24 shows. The delay time is the amount of time between loading new configurations into the BUF22821.

Use the **Single Step Up** and **Single Step Down** buttons to step through the selected files manually. The currently-selected file name is displayed in the lower left corner area of the dialog box. Double-click on the file names to select them. Once the names have been selected, the check box turns dark. Double-click on the file name again to unselect it from the batch run. In Figure 24, two configuration files are selected.

6.2.10 Control Panel Button

Pressing the **Control Panel** button brings up a display panel that allows you to adjust each channel using a set of graphical sliders, as shown in Figure 25. Simply drag the slider to adjust the desired channel output. The DAC code and corresponding output value of each channel changes automatically. This action is similar to the slider present on the main BUF22821EVM-USB software window that changes based on the channel that is highlighted.

Figure 25. Control Panel Window

6.2.11 Program OTP All Channels Button

As Figure 26 shows, pressing the Program OTP All Channels button allows you to program a gamma curve into the nonvolatile memory in the BUF22821. All 22 channels (including the VCOM channels) are then programmed simultaneously. The values are stored in the memory bank that is selected via the BKSEL switch (see Section 4.4).

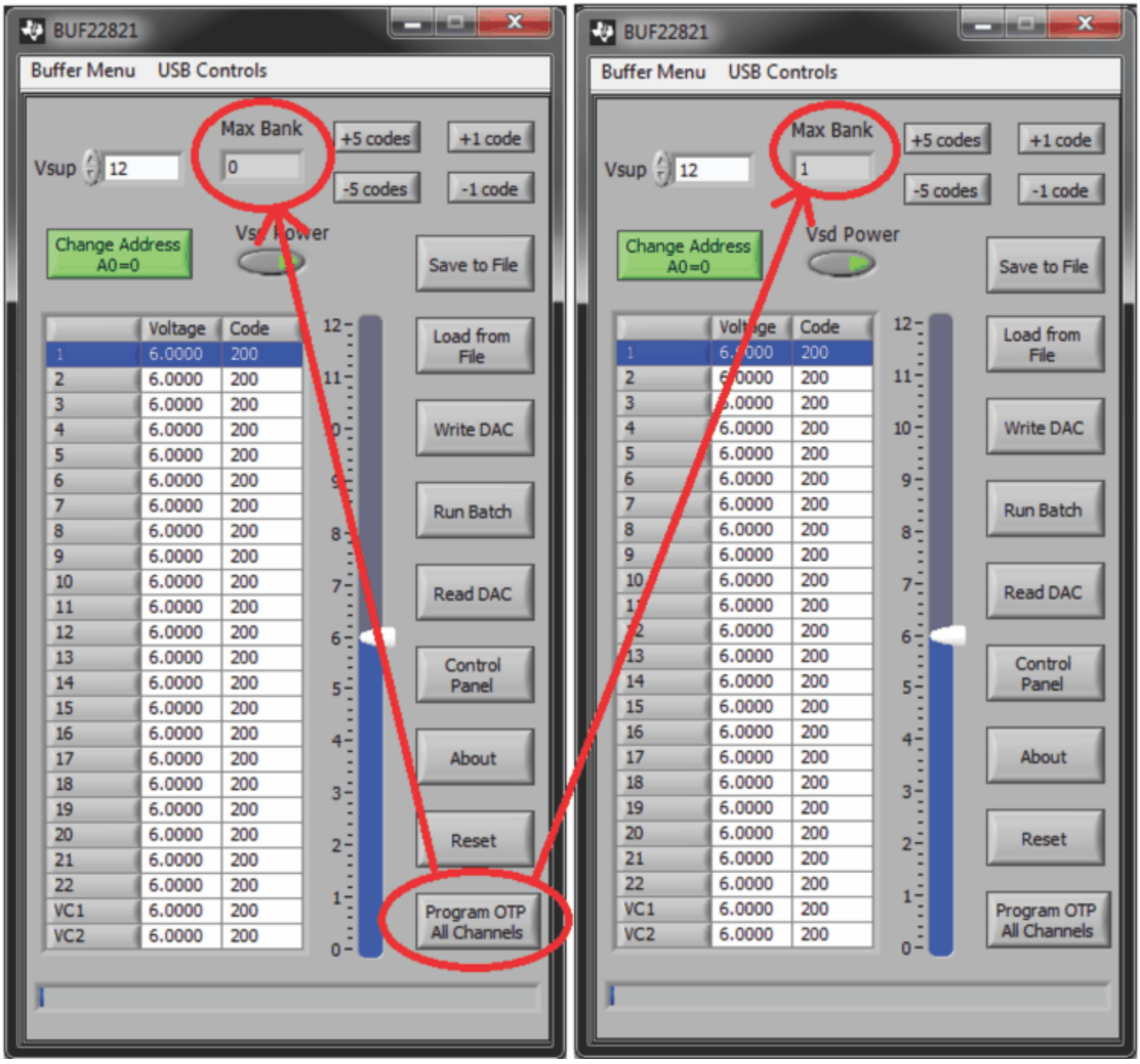

Figure 26. Program OTP All Channels

7 BUF22821EVM-USB Documentation

This section contains the complete bill of materials and PCB layout for the BUF22821EVM-USB.

NOTE: These board layouts are not to scale. These image are intended to show how the board is laid out; they are not intended to be used for manufacturing BUF22821EVM-USB PCBs.

7.1 BUF22821EVM-USB Board Schematic

Figure 27 shows the schematic for the BUF22821EVM-USB board.

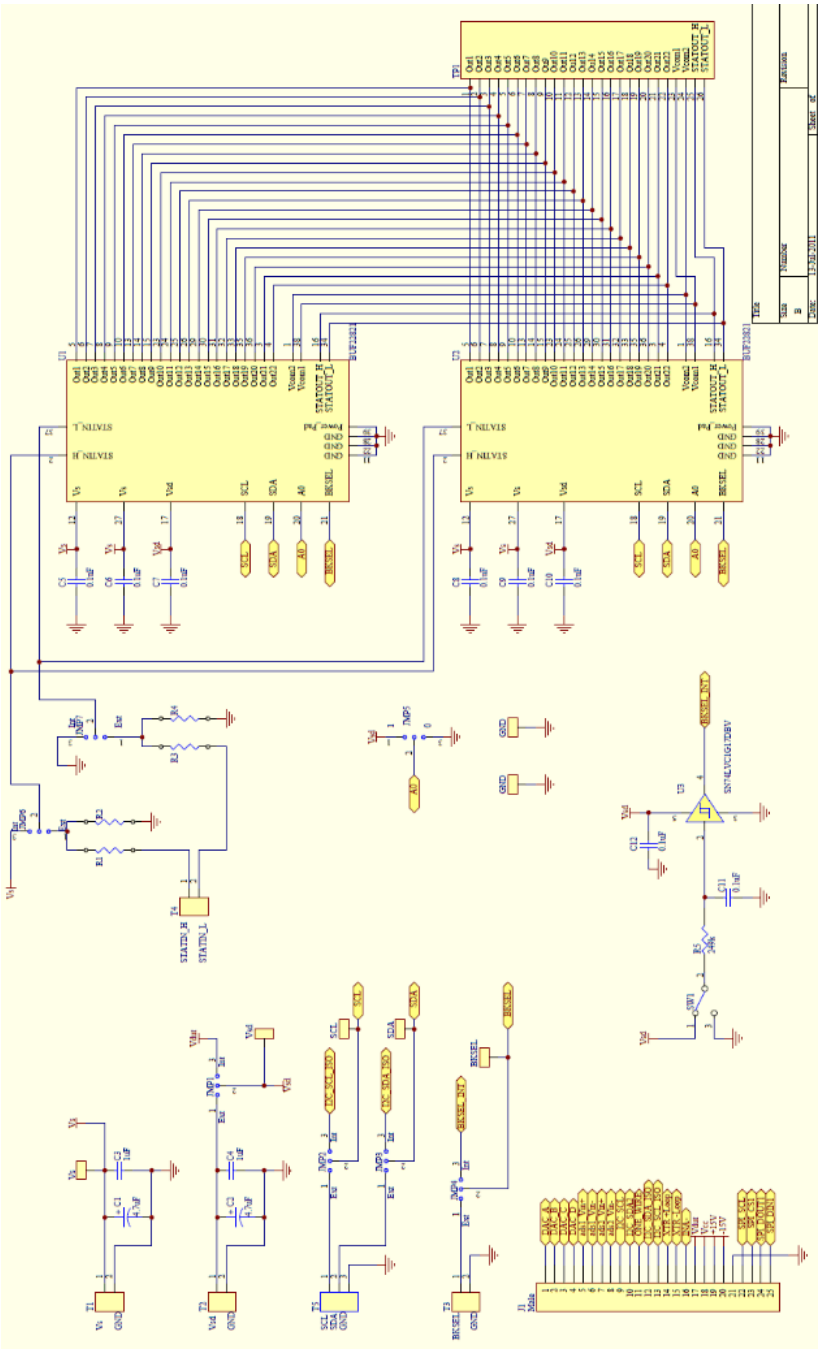

Figure 27. BUF22821EVM-USB Board Schematic

7.2 PCB Layout

Figure 28 shows the PCB layout of the BUF22821EVM-USB.

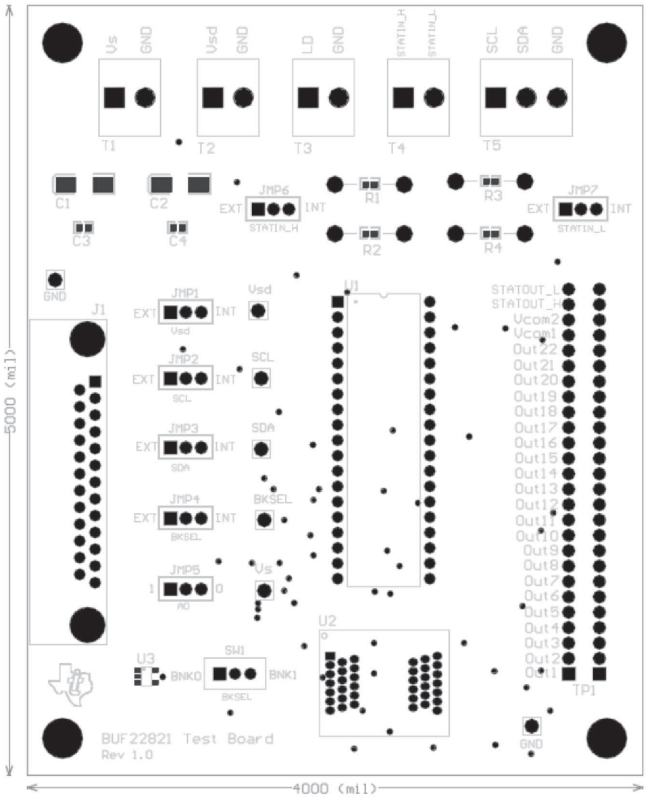

Figure 28. BUF22821EVM-USB PCB Top Layer (Component Layout)

7.3 Bill of Materials

Table 6 lists the bill of materials for the BUF22821EVM-USB.

Table 6. BUF22821EVM-USB Test Board Bill of Materials

Item No.	Qty	Value	Ref Des	Description	Vendor/Mfr	Part Number
1	4	Various	R1 to R4	Resistor, 1/16W 5% 0603 SMD	Susumu Co Ltd	Various
2	1	249 kΩ	R5	Resistor, 249 kΩ, 1/16W 5% 0603 SMD	Susumu Co Ltd	RR0816P-2493-D-39D
3	2	4.7 µF	C1, C2	Capacitor, tantalum, 4.7 µF 35 V 10% SMD	Vishay/Sprague	293D475X9035C2TE3
4	2	1 µF	C3, C4	Capacitor, ceramic, 1 µF 25 V Y5V 0603	Murata Electronics North America	GRM188F51E105ZA12D
5	8	0.1 µF	C5 to C12	Capacitor ceramic, 0.1 µF 25 V Y5V 0603	Kemet	C0603C104Z3VACTU
6	1	—	U1	Connector, Rcpt .100 in, 19-Pos Gold T/H	Samtec	SS-119-G-2
7	2	—	U2	Socket, TSSOP 28-Pin ZIF	ENPLAS	OTS-38(44)-0.5-01
8	1	—	U3	IC Buffer, Schmitt Trigger, SOT235	Texas Instruments	SN74LVC1G17DBVR
9	1	DSUB25	J1	Connector, D-SUB Plug R/A 25-Pos 30 Gold (with threaded inserts and board locks)	AMP/Tyco Electronics	5747842-4
10	4	—	T1 to T4	Terminal block 5 MM 2 Pos	On-Shore Technology Inc	ED300/2
11	1	—	T5	Terminal block 5 MM 3 Pos	On-Shore Technology Inc	ED300/3
12	1	—	TP1	Connector, Header 26-Pos .100 in., SGL Gold	Samtec	TSW-126-07-G-S
13	7	—	All Test Points (V_S, V_{SD}, SCL, SDA, BKSEL, GNDx2)	Connector, Header 1-Pos .100 in., SGL Gold	Samtec	TSW-101-07-G-S
14	4	Standoff	None	Standoffs, Hex , 4-40 Threaded, 0.500 in., length, 0.250 in. OD, Aluminum Iridite Finish	Keystone	2203
15	4	Screw	None	Screw Machine Phillips, 4-40X1/4 SS	B & F Fastener Supply	PMSSS 440 0025 PH
16	1	SW1	SW1	Switch Toggle SPDT .4 VA PC MNT	E-Switch	200AWMSP1T1A1M2RE
17	7	Strip cut to size (length is 3 pos.)	JMP1 to JMP7	Connector, Header 3-Pos .100 in., SGL Gold	Samtec	TSW-103-07-G-S
18	7	Jumper	JMP1 to JMP7	Shunt LP w/Handle 2-Pos 30AU	AMP/Tyco Electronics	881545-2

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Caution

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Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

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FCC Interference Statement for Class B EVM devices

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

For EVMs annotated as IC – INDUSTRY CANADA Compliant

This Class A or B digital apparatus complies with Canadian ICES-003.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

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This device complies with Industry Canada licence-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Concerning EVMs including detachable antennas

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication.

This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Cet appareil numérique de la classe A ou B est conforme à la norme NMB-003 du Canada.

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3. Use of this product only after you obtained the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to this product. Also, please do not transfer this product, unless you give the same notice above to the transferee. Please note that if you could not follow the instructions above, you will be subject to penalties of Radio Law of Japan.

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3. You will employ reasonable safeguards to ensure that your use of the EVM will not result in any property damage, injury or death, even if the EVM should fail to perform as described or expected.
4. You will take care of proper disposal and recycling of the EVM's electronic components and packing materials.

Certain Instructions. It is important to operate this EVM within TI's recommended specifications and environmental considerations per the user guidelines. Exceeding the specified EVM ratings (including but not limited to input and output voltage, current, power, and environmental ranges) may cause property damage, personal injury or death. If there are questions concerning these ratings please contact a TI field representative prior to connecting interface electronics including input power and intended loads. Any loads applied outside of the specified output range may result in unintended and/or inaccurate operation and/or possible permanent damage to the EVM and/or interface electronics. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative. During normal operation, some circuit components may have case temperatures greater than 60°C as long as the input and output are maintained at a normal ambient operating temperature. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors which can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during normal operation, please be aware that these devices may be very warm to the touch. As with all electronic evaluation tools, only qualified personnel knowledgeable in electronic measurement and diagnostics normally found in development environments should use these EVMs.

Agreement to Defend, Indemnify and Hold Harmless. You agree to defend, indemnify and hold TI, its licensors and their representatives harmless from and against any and all claims, damages, losses, expenses, costs and liabilities (collectively, "Claims") arising out of or in connection with any use of the EVM that is not in accordance with the terms of the agreement. This obligation shall apply whether Claims arise under law of tort or contract or any other legal theory, and even if the EVM fails to perform as described or expected.

Safety-Critical or Life-Critical Applications. If you intend to evaluate the components for possible use in safety critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, such as devices which are classified as FDA Class III or similar classification, then you must specifically notify TI of such intent and enter into a separate Assurance and Indemnity Agreement.

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